

PRODUCT CHANGE NOTICE

1. TITLE Packaging Type, Jedec Trays		2. DOCUMENT NUMBER FV5-C-18-0072
		3. DATE June 18, 2018
4. MANUFACTURER AND ADDRESS International Rectifier HiRel Products, Inc 205 Crawford Street Leominster, MA 01453		5. MANUFACTURER PART NUMBER General
		6. BASE PART NA
		7. NATIONAL STOCK NUMBER (NSN) NA
8. CAGE 69210	9. EFFECTIVE DATE July 2, 2018	10. GOVERNMENT NUMBER NA
11. POINT OF CONTACT Manufacturer's Representative or Account Specialist (978) 534-5776		12. DRAWING NUMBER NA
		13. SPECIFICATION NUMBER MIL-PRF-19500
14. PRODUCT CHANGE <p>This GIDEP PCN is to announce a change in the packaging of International Rectifier HiRel products parts. Starting July 2, 2018, new JEDEC trays will be phased in to replace the current clear thermoformed trays used to package discrete semiconductor parts. The change in packaging trays provides better protection during transportation and will maintain the same permanent static dissipative properties with a surface resistance of less 1×10^{11} ohms.</p> <p>See images below for example of new JEDEC Trays packaging.</p> <div data-bbox="77 1033 922 1390" data-label="Image"> </div>		
<p>JEDEC trays will be used for the following standard packages and lead configuration styles:</p> <ul style="list-style-type: none"> • SMD 0.2 • SMD 0.5 • TO-257 • LCC18 • SupIR SMD <p>Packages with alternate lead configurations such as parts with lead attach or lead bends will require the use of clear thermoformed trays.</p>		
16. APPROVING GOVERNMENT ACTIVITY		
17. GIDEP REPRESENTATIVE Paul Hebert	18. SIGNATURE 	19. DATE June 18, 2018